
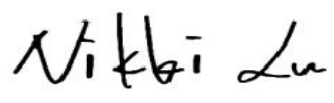



# PSE Technology Corporation

## SPECIFICATION FOR APPROVAL

CUSTOMER	_____
NOMINAL FREQUENCY	<b>12.000000 MHz</b>
PRODUCT TYPE	<b>TYPE FQ 3.2x2.5 GLASS SEALED CRYSTAL</b>
PART NUMBER	<b>FQ1200007</b>
CUSTOMER P/N	_____
ISSUE DATE	<b>May 30, 2013</b>
VERSION	<b>A</b>

APPROVED	PREPARED	QA
		
APPROVED BY CUSTOMER		
Please return one copy with approval to PSE-TW		

### PSE Technology Corporation

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 Chung Li City, Taoyuan County, Taiwan (R.O.C.)  
 TEL:886-3-451-8888  
 FAX:886-3-461-3865  
<http://www.saronix-ecera.com.tw/>

- \*RoHS Exemption
- \*HF-Halogen Free
- \*REACH Compliant

**A Company of PERICOM Semiconductor Corporation**

# TYPE FQ 3.2x2.5 GLASS SEALED CRYSTAL

**FQ1200007**

VER.A 30-MAY-13

## VERSION HISTORY

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
A	May. 30, 2013			Initial Release	

# TYPE FQ 3.2x2.5 GLASS SEALED CRYSTAL

**FQ1200007**

VER.A 30-MAY-13

## ELECTRICAL SPECIFICATIONS

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	12.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	18	pF	
Calibration Tolerance	FL	± 20	ppm	at 25°C±3°C
Operating Temperature Range	TR	-40 to +85	°C	
Frequency Stability(Frequency Deviation over the Operating Temperature Range)	F/T	± 30	ppm	Reference to the Frequency at 25°C
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	120	Ω	Max.
Shunt Capacitance	C0	3	pF	Max.
Aging at 25°C		± 3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	MΩ	Min

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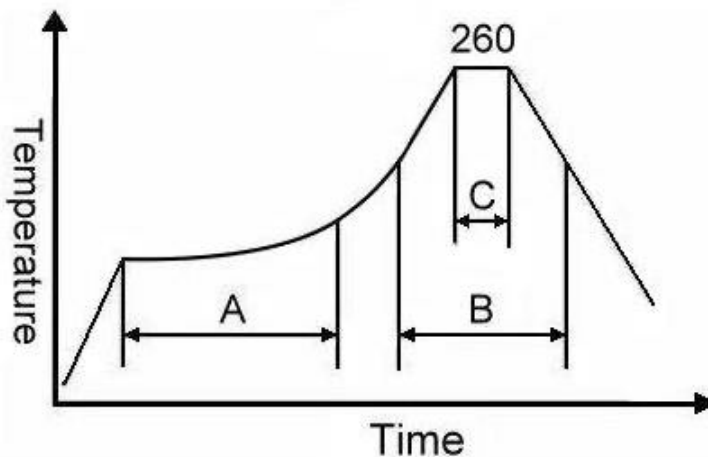
## RELIABILITY SPECIFICATIONS

### MECHANICAL AND ENVIRONMENTAL RATINGS:

- a) FINE LEAK TEST: JESD22-A109 (Condition 1A)
- b) GROSS LEAK TEST: JESD22-A109 (Condition C)
- c) MOISTURE RESISTANCE: JESD22-A113
- d) SHOCK: JESD22-B104 (Condition B)
- e) SOLDERABILITY : (RoHS version): J-STD-002
- f) VIBRATION: JESD22-B103
- g) SOLVENT RESISTANCE: JESD22-B107
- h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

## SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D



Note:

	Stage	Temperature	Time
A	Preheat	150~200°C	60~120 Sec
B	Primary Heat	217°C	60~150 Sec
C	Peak	260°C	10 Sec

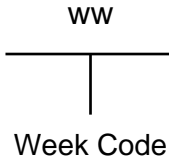
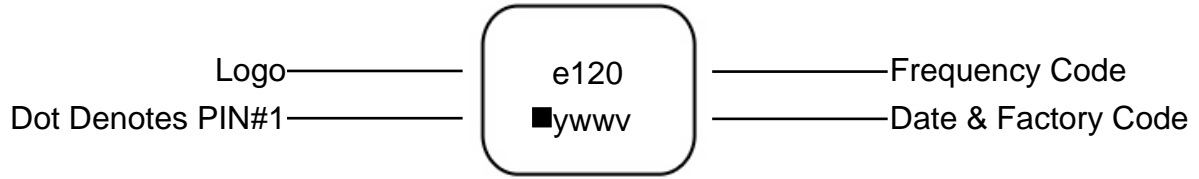
For soldering reflow profile and reliability test ratings go to: <http://www.pericom.com/pdf/sre/reflow.pdf>

# TYPE FQ 3.2x2.5 GLASS SEALED CRYSTAL

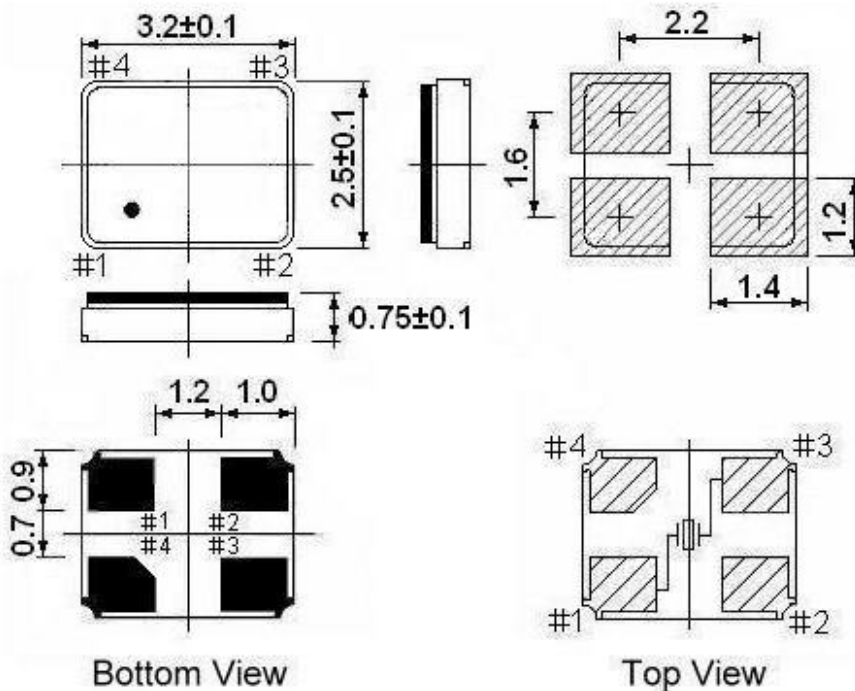
FQ1200007

VER.A 30-MAY-13

## MARKING



## MECHANICAL DRAWINGS ( Scale: None. Dimensions are in mm.)



\*\* Recommended - Pin 1 & 3 : CRYSTAL  
Pin 2 & 4 : GND

Note:

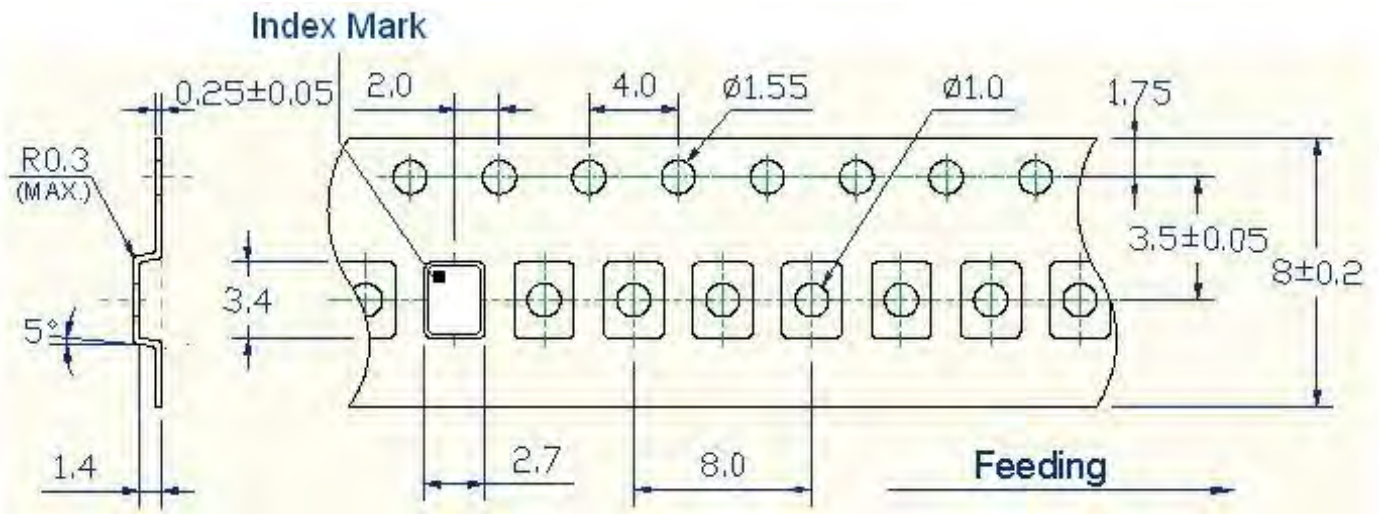
1. The marking dot denotes Pin#1.
2. Pin positions of the drawing is only for reference, and the Pin with chamfer is based on the real product.

# TYPE FQ 3.2x2.5 GLASS SEALED CRYSTAL

FQ1200007

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## Tape & Reel



1. 230mm minimum leader which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

# TYPE FQ 3.2x2.5 GLASS SEALED CRYSTAL

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## PACKING

